HL 海罗光电有限公司 Hello Lighting co.,LTD	Specification document
	www.hello-lighting.com

SPECIFICATION
OF
LCD MODULE

MODULE NO.: HL068T01-01

Customer Approval:

☐ **Accept** ☐ **Reject**

	SIGNATURE	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

DOCUMENT REVISION HISTORY

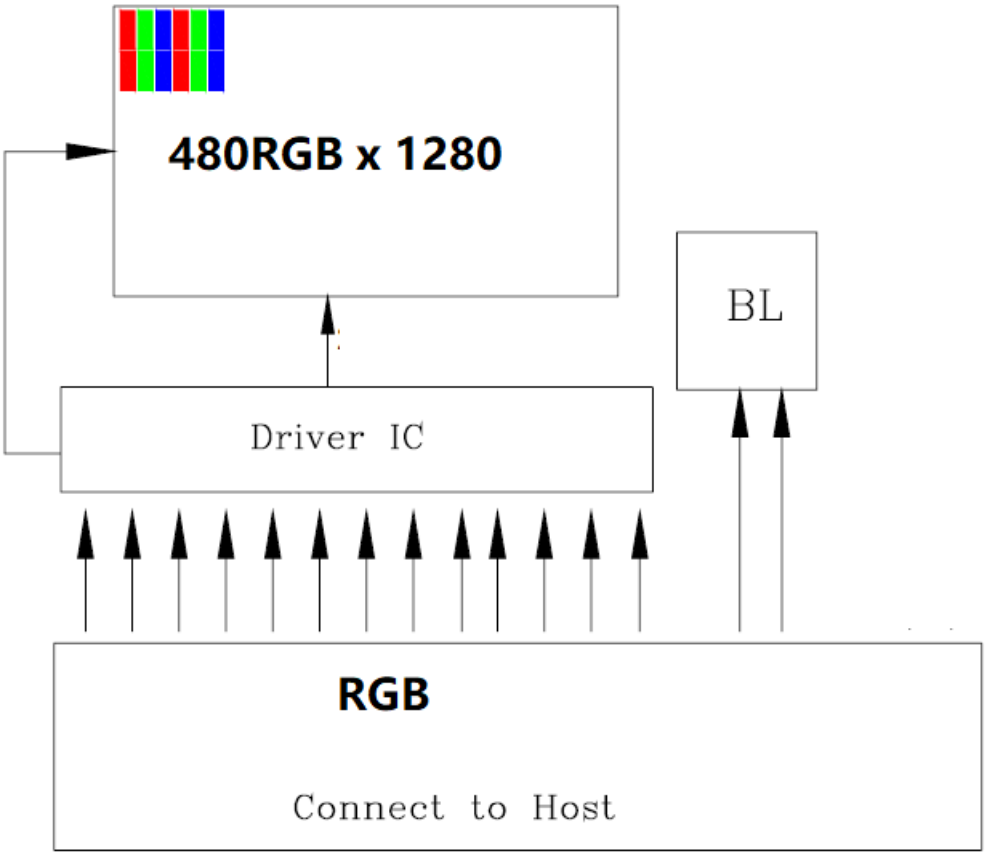
Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
	A0	2025-4-7	First Release.	

1. MECHANICAL SPECIFICATIONS:

ITEM	SPECIFICATION	UNIT
OUTLINE DIMEMSIONS	181.2 (W) X66.9 (H) X4.6(D)	mm
ACTIVE AREA	160.51 (W) X 60.19 (H)	
DISPLAY SIZE	6.86	inch
DOT PITCH	0.12mmX0.12mm	mm
NUMBER OF DOTS	480*（RGB）*1280	-
LCD TYPE	TFT(16.7M) TRANSMISSIVE	-
BACKLIGHT TYPE	LED White	-
VIEWING DIRECTION	FREE	-
TOUCH PANEL	NONE	

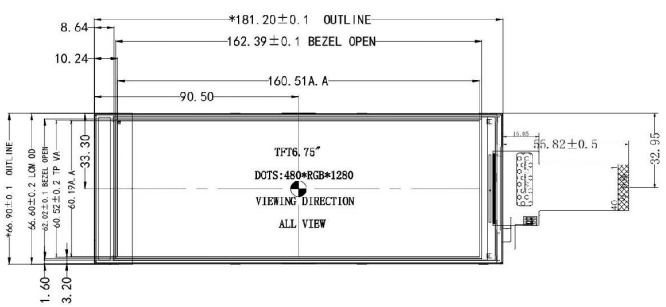
***See attached drawing for details.**

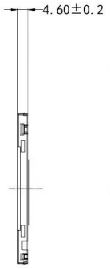
2.BLOCK DIAGRAM:

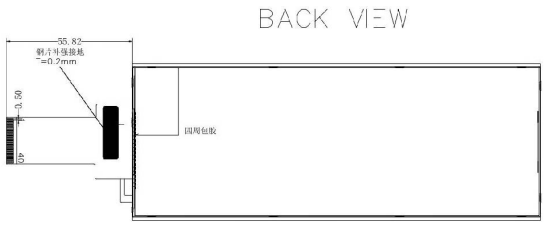


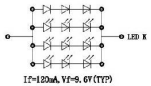
3.DIMENSIONAL

正视图　　侧视图　　背视图









Backlit circuit diagram

1	LED-	21	B0		
2	LED+	22	B1		
3	GND	23	B2		
4	VDD	24	B3		
5	R0	25	B4		
6	R1	26	B5		
7	R2	27	B6		
8	R3	28	B7		
9	R4	29	GND		
10	R5	30	DCLK		
11	R6	31	DISP		
12	R7	32	HSYNC		
13	G0	33	VSYNC		
14	G1	34	DE		
15	G2	35	NC		
16	G3	36	GND		
17	G4	37	SCL		
18	G5	38	SDA		
19	G6	39	CS		
20	G7	40	NC		

Display Type	6.86" TFT-LCD,transmissive, normal black
Display Resolution	480GB(H)*12800(V)
Interface	MIPI
Logic Voltage	3.3V
Operation Temperature	-20°C TO 70°C
Storage Temperature	-30°C TO 80°C
Remark	

MARK	REV		DATE
	1.0	First version	
		CONTENTS MODIFIED	

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HL068TI01-01

TITLE: LCM DIMENISION			
DESIGN		REV. : 2.0	SCALE : -
CHECKED		PROJECTION:	
APPROVED			

4. PIN DESCRIPTION:

NO.	PIN NAME	I/O	Description
1	VBL-	P	Backlight LED Cathode
2	VBL+	P	Backlight LED Anode
3	GND	P	System Ground
4	VCC	P	Power supply for logic operation
5	**R0**	I	Red data input(LSB)
6	R1	I	Red data input
7	R2	I	Red data input
8	R3	I	Red data input
9	R4	I	Red data input
10	R5	I	Red data input
11	R6	I	Red data input
12	R7	I	Red data input(MSB)
13	G0	I	Green data input(LSB)
14	G1	I	Green data input
15	G2	I	Green data input
16	G3	I	Green data input
17	G4	I	Green data input
18	G5	I	Green data input
19	G6	I	Green data input
20	G7	I	Green data input(MSB)
21	B0	I	Blue data input(LSB).
22	B1	I	Blue data input
23	B2	I	Blue data input
24	B3	I	Blue data input
25	B4	I	Blue data input
26	B5	I	Blue data input
27	B6	I	Blue data input
28	B7	I	Blue data input(MSB)
29	GND	P	Ground
30	CLK	I	Pixel clock signal ,in RGB mode
31	DISP	I	Display on/off control
32	HSYNC	I	Horizontal Sync signal in RGB mode
33	VSYNC	I	Vrtical Sync signal
34	DEN	I	Data Enable
35	NC	-	No connect
36	GND	P	System Ground
37	SCL	I	Serial clock
38	SDA	IO	Serial data
39	CS	I	Chip selction
40	NC	-	No connection

5. MAXIMUM ABSOLTE LIMIT:

Item	Symbol	Value	Unit
Power supply voltage for core	V_{DD}	-0.3~4	V
Input voltage	Vin	V_{DD}+0.3	V
Operating temperature	Topr	-20 to 70	°C
Storage temperature	Tstg	-30 to 80	°C

Note: Note1: Absolute maximum rating is the limit value beyond which the IC maybe broken. They do not assure operations.

Note2: Background color changes slightly depending on ambient temperature. This Phenomenon is reversible.

Ta≦70℃: 75%RH max

Ta>70℃: absolute humidity must be lower than the humidity of 75%RH at 70℃

Note3: Ta at -30℃ will be <48hrs, at 80 ℃ will be <120hrs

6.ELECTRICAL CHARACTERISTICS

6-1 DC Characteristics (Ta=25°C)

Item	Symbol	Min	Type	Max	Unit	Test condition
Operating voltage for core	V_{DD}	3.0	3.3	3.6	V	-
Supply current	I_{DD}	-	TBD	-	mA	V_{DD}=3.3V,Ta=25°C
Input voltage	V_{IH}	0.7VDD	-	VDD	V	-
	V_{IL}	0	-	0.3VDD	V	
Input leakage current	I_{IL}	-1.0	-	1.0	μA	V_{IN}=V_{DD} or V_{SS}

Note: Voltage greater than above may damage the module.

All voltages are specified relative to V_{SS}=0V.

6-2 Backlight Electrical-optical Characteristics

1. Stander Lamp Styles(Edge Lighting Type):

The LED chips are distributed over the edge light area of the illumination unit, which gives the less power consumption:

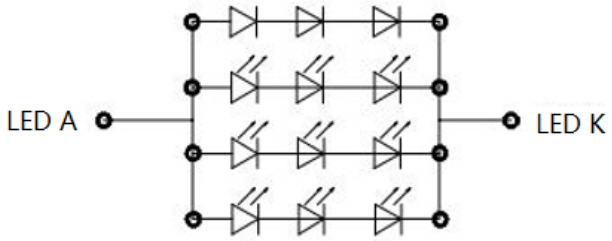
2. The Main Advantages of the LED Backlight are as following:

2.1 The brightness of the backlight can simply be adjusted by a resistor or a potentiometer.

3. Data About LED Backlight:

Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition	Note
Supply Voltage	Vf	-	9.6	10.2	V	If=120 mA	-
Supply Current	If	-	120	-	mA	-	-
Reverse Voltage	Vr	-	-	5	V	10uA	
Power dissipation	Pd	-	1152	-	mW	-	
Uniformity for LCM	-	80	-	-	%	If=120mA	3
Life Time	-	30000	-	-	Hr	If=120 mA	-
Backlight Color	White						

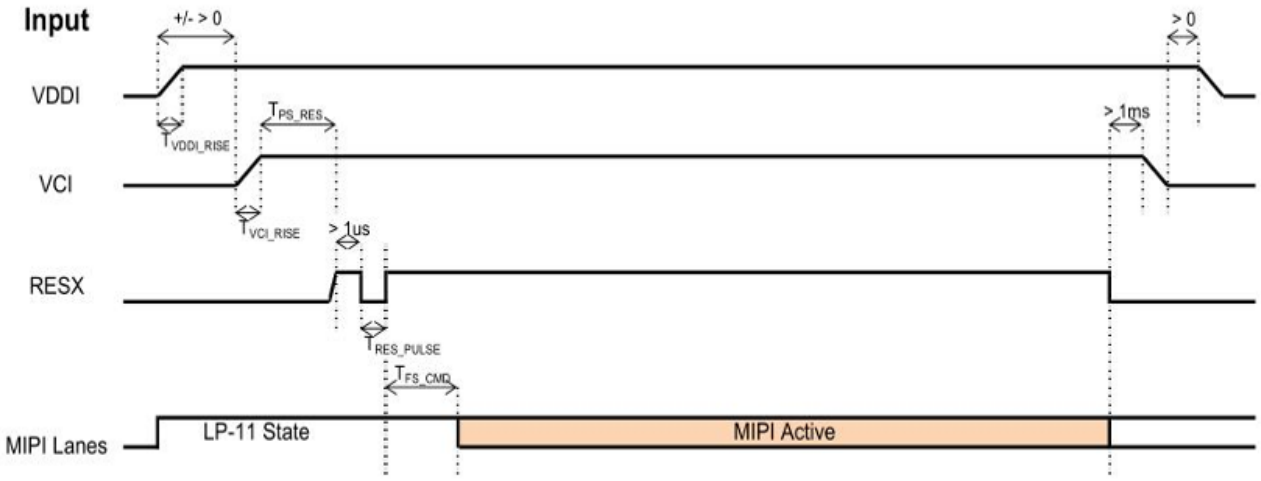
1. Average Luminous Intensity of P1-P9
2. Uniformity = Min/Max * 100%
3.LED life time defined as follows: The final brightness is at 50% of original brightness



7.AC TIMING

480RGBx1280(4 Data Lanes)						
Parameter		Symbol	Min.	Typ.	Max.	Unit
MIPI data frequency		FDATA	300	320	350	Mbps
Clock frequency		FRAME		60		HZ
Hertical Section	Active	THD		480		us
	Period	TH	482.5	512	-	us
	HBP	THBP	1	12	-	us
	HFP	THFP	1	16	-	us
	HSYNC	THPW	0.2	4	-	us
Vorizontal Section	Active	TVD		1280		Line
	Period	TV	1286	1312	-	Line
	VBP	TVBP	2	12	-	Line
	VFP	TVFP	2	16	-	Line
	VSYNC	FTPW	2	4	-	Line

7.1 Power ON/OFF Sequence



Symbol	Characteristics	Min.	Typ.	Max.	Units
T_{VDDI_RISE}	VDDI Rise time	20	-	-	us
T_{VCI_RISE}	Case A: VCI Rise time	200	-	-	us
	Case B: VCI Rise time	40			
T_{PS_RES}	VDDI/VCI on to Reset high	5	-	-	ms
T_{RES_PULSE}	Reset low pulse time	10	-	-	us
T_{FS_CMD}	Reset to first command	10	-	-	ms

8. OPTICAL CHARACTERISTICS:

Driving the backlight

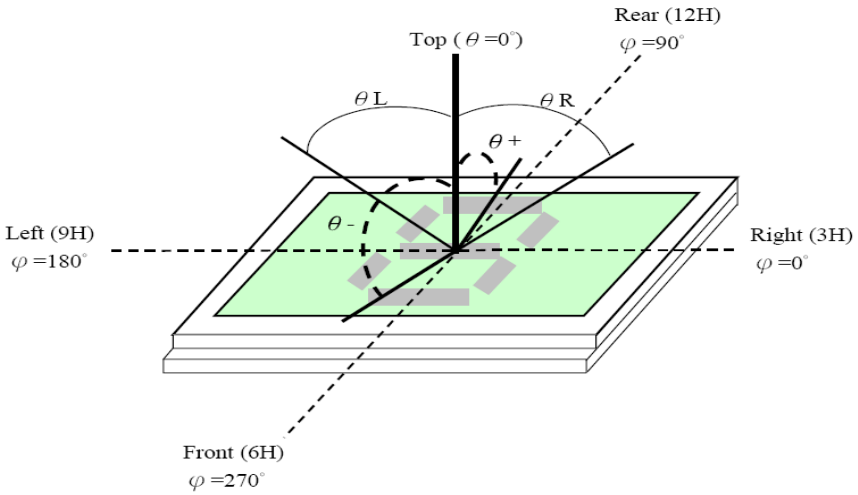
No.	ITEM		Symbol	Conditions	Specification			Unit	Note
					Min	Typ	Max		
1	Response Time		Tr+Tf	25℃	-	25	40	Ms	(1)(2)
2	Contrast Rate		Cr	θ=0, Normal viewing angle	600	800	-	-	(1)(3)
3	Viewing Angle	Hor.	θL	CR>10	70	80	-	Deg	-
			θR		70	80	-		
		Ver.	Θ+		70	80	-		
			Θ-		70	80	-		
4	Chromaticiry	White	x	Brightness is ON	0.278	0.298	0.318		
			y		0.311	0.331	0.51		
		Red	x		0.587	0.607	0.627		
			y		0.310	0.330	0.350		
		Green	x		0.258	0.278	0.298		
			y		0.526	0.546	0.566		
		Blue	x		0.121	0.141	0.161		
			y		0.138	0.158	0.178		
5	NTSC		S			50		%	
6	luminance		L		240	300		cd/m2	
7	Uniformity		U		80			%	

Measure Conditions:

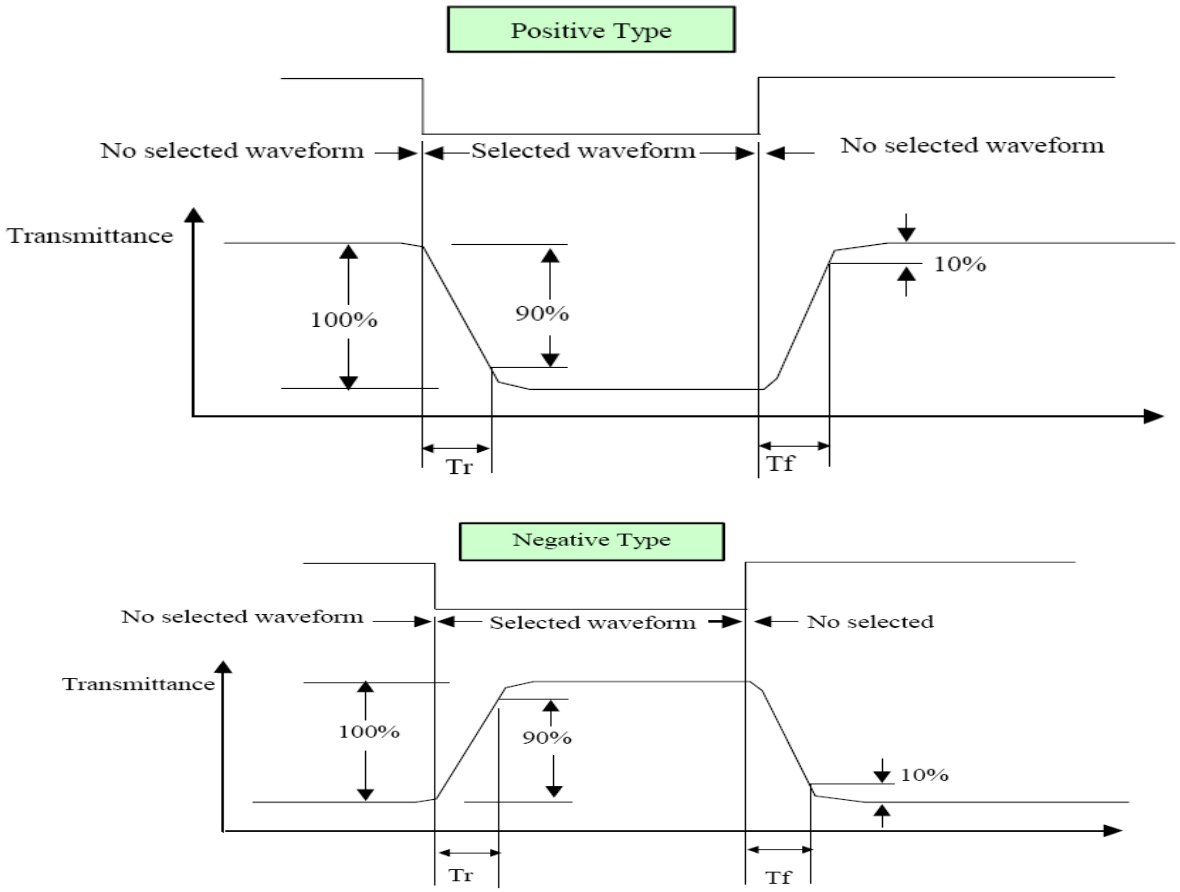
1. Measure surrounding : dark room;
2. Ambient temperature: 25±2℃;
3. 30min.warm-up time.

Note Definition:

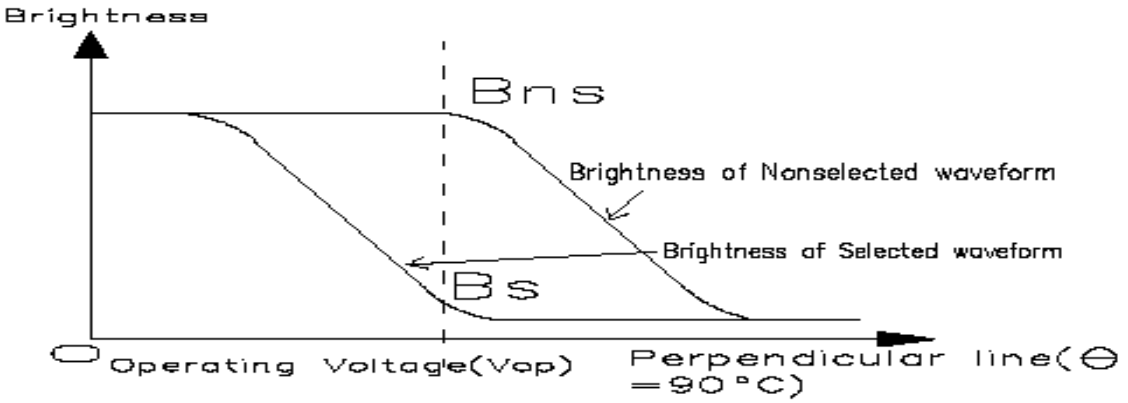
Note(1)Viewing angle range:



Note(2)Response Time:



Note(3)Contrast Ratio Definition:

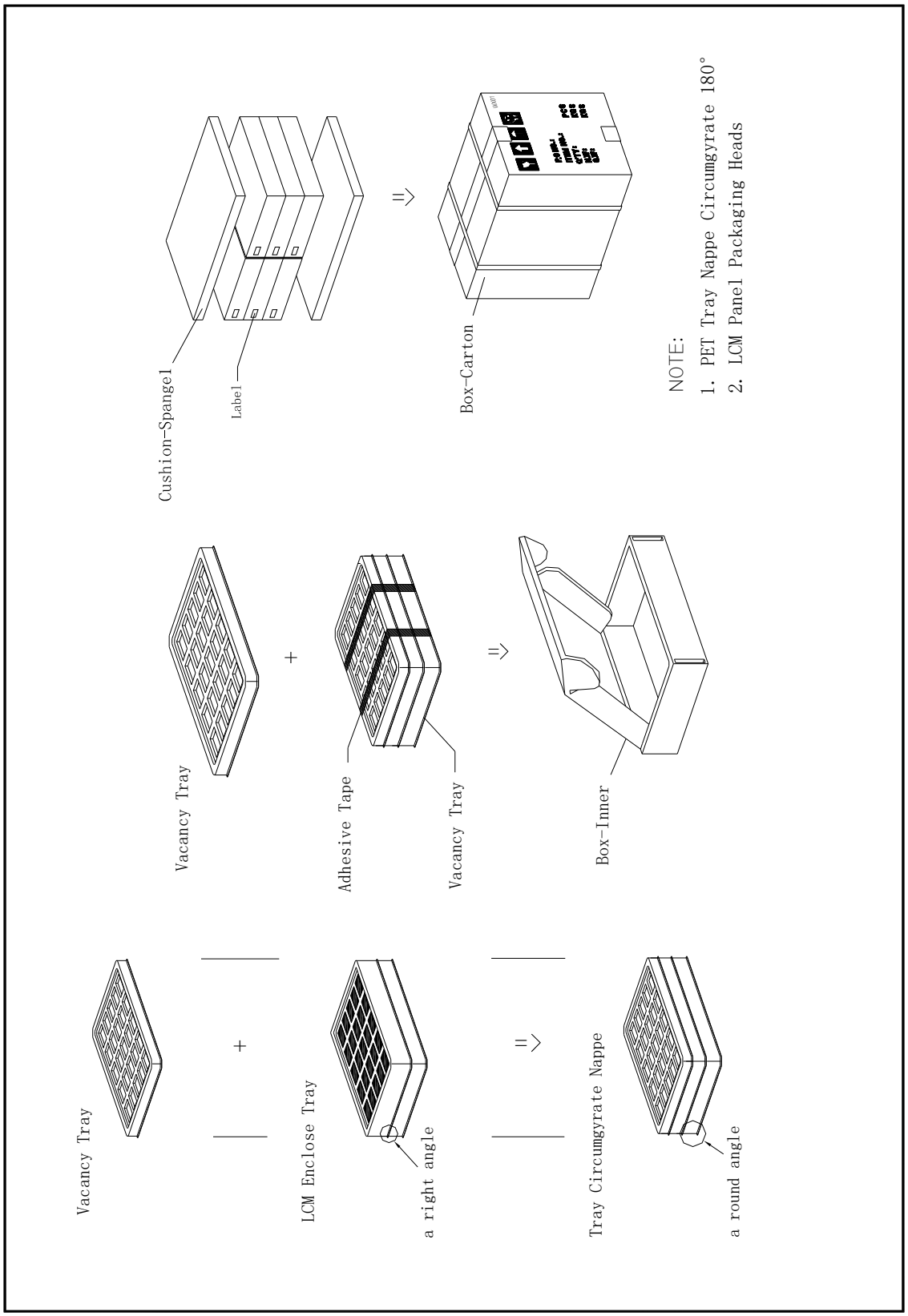


Luminance with all pixel white

Contrast Ratio (Cr)= ——————————————

Luminance with all pixel black

9.PACKAGE.


Cushion-Spangel
Label
Box-Carton
NOTE:
1. PET Tray Nappe Circumgyrate 180°
2. LCM Panel Packaging Heads
Vacancy Tray
Adhesive Tape
Vacancy Tray
Box-Inner
Vacancy Tray
LCM Enclose Tray
a right angle
Tray Circumgyrate Nappe
a round angle

10. STANDARD SPECIFICATION FOR RELIABILITY:

Item	Condition		Time (hrs)	Assessment
High temp. Storage	80°C		120	No abnormalities in functions and appearance
High temp. Operating	70°C		120	
Low temp. Storage	-30°C		120	
Low temp. Operating	-20°C		120	
Humidity	40°C/ 90%RH		120	
Thermal Shock Temp. Cycle	-20°C ← →70°C (0.5hour ← → 0.5 hour)		10cycles	
ESD Testing	HBM:	±8KV		330Ω/150PF
	MM:	±200V		200PF/0Ω

Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25±10℃), normal humidity (45±20% RH), and in area not exposed to direct sun light. (Life time of backlight, please refer to Data about backlight.)

Testing Conditions and Inspection Criteria:

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in up Table, Standard specifications for Reliability have been executed in order to ensure stability.

Item	Test Model	In section Criteria
Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
Appearance	Visual inspection	Defect free.

11.SPECIFICATION OF QUALITY ASSURANCE:

11.1 Purpose

This standard for Quality Assurance should affirm the quality of LCD Module products to supply.

11.2 Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

(i) Test method: According to MIL-STD105E.General Inspection Level Ⅱ take a single time.

(ii) The defects classify of AQL as following:

Major defect: AQL = 0.65

Minor defect: AQL = 2.5

Total defects: AQL = 2.5

11.3. Nonconforming Analysis & Deal With Manners

a. Nonconforming Analysis:

(i) Purchaser should supply the detail data of non- conforming sample and the non- conforming.

(ii) After accepting the detail data from purchaser, the analysis of nonconforming should be finished in two weeks.

(iii) If supplier can not finish analysis on time, must announce purchaser before two weeks.

b. Disposition of nonconforming:

(i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.

(ii) Both supplier and customer should analyze the reason and discuss the disposition of nonconforming when the reason of nonconforming is not sure.

11.4. Agreement items

Both sides should discuss together when the following problems happen.

a. There is any problem of standard of quality assurance, and both sides think that it must be modified.

b. There is any argument item which does not record in the standard of quality assurance.

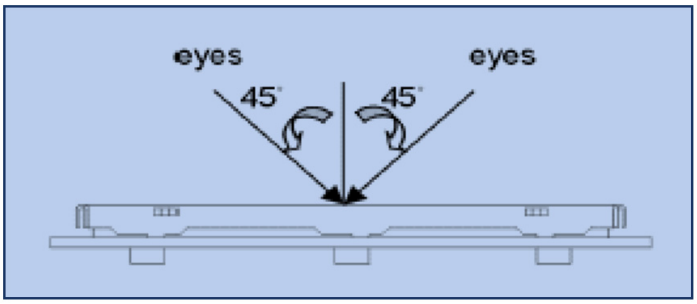
c. Any other special problem.

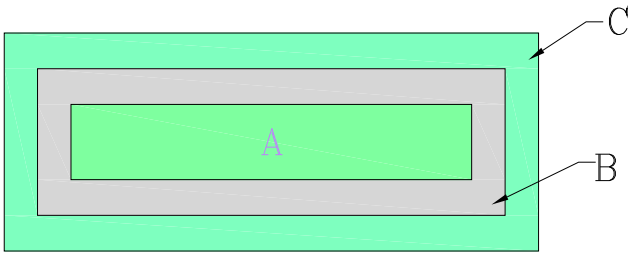
11.5 Standard of The Product Appearance Test

a. Manner of appearance test: This specification should be applied for both light on and off situation.

(i) The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.

(ii) When test the model of transmissive product must add the reflective plate.
(iii)The test direction is base on about around 10° of vertical line (Left graph)
(iiii)Temperature: 25±5℃ Humidity: 65±10%RH





(iv) Definition of area (Right graph)
A. Area: Viewing area. B. Area: Out of viewing area.(Outside viewing area)
b. Basic principle:
(i) It will accord to the AQL when the standard can not be described.
(ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
(iii) Must add new item on time when it is necessary.
c. Standard of inspection: (Unit: mm)

Allowable limits defined in follow Dot defect Table should be met for each white, black , R, G, B raster. The limits apply to the entire area. Missing white in 60% or more of typical (one color, R or G or B) pixel aperture is defined as a bright defect, less than 60% is acceptable .Black spot in 60% or more of typical pixel aperture is defined as a dark defect, less than 60% is acceptable.

Dot defect table:

Item		White dot defect	Black dot defect	Total
1	Defect counts	3	3	3
2	Combined defect Counts	No combined dot defect allowed. Two Single dot defect that within 5mm during each dot defect should becounted as combined dot defect.		

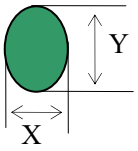
11.6 Inspection specification

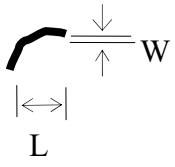
AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

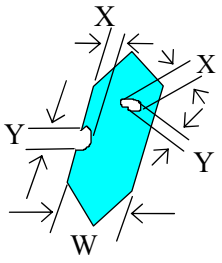
Classify	Item		Note	AQL
Major	Display state	Short or open circuit	1	0.65
		Contrast defect (dim, ghost)		
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction	2	
		Wrong Back-light	7	
	Non-display	Flat cable or pin reverse	9	
		Wrong or missing component	10	
Minor	Display state	Background color deviation	2	2.5
		Black spot and dust	3	
		Line defect	4	
		Scratch		
		Rainbow	5	
		Pin hole	6	
	Polarizer	Bubble and foreign material	3	
		Scratch	4	
	PCB,FPC	Scratch	4	
	Soldering	Poor connection	8	
	Wire	Poor connection	9	
	LCD	CHIP OUT	11	

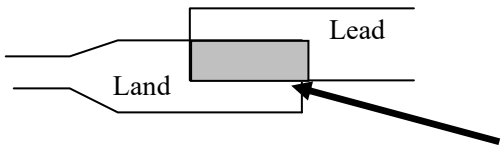
Note on defect classification:

<table>
<tr><th>No.</th><th>Item</th><th>Criterion</th></tr>
<tr><td rowspan="6">1</td><td>Short or open circuit</td><td rowspan="6">Not allow</td></tr>
<tr><td>LC leakage</td></tr>
<tr><td>Flickering</td></tr>
<tr><td>No display</td></tr>
<tr><td>Wrong viewing direction</td></tr>
<tr><td>Wrong Back-light</td></tr>
<tr><td rowspan="2">2</td><td>Contrast defect</td><td rowspan="2">Refer to approval sample</td></tr>
<tr><td>Background color deviation</td></tr>
<tr><td>3</td><td>Point defect,
Black spot, dust (incl. Polarizer) ex.: dirt under polarizer,
Pinhole of reflector ,glass scratch, dirt under glass,scratch on polarizer
ϕ = (X+Y)/2</td><td> 

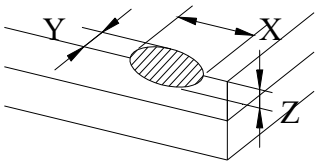
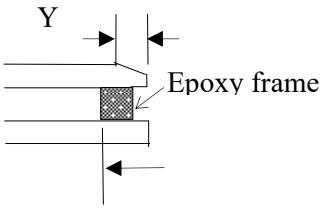
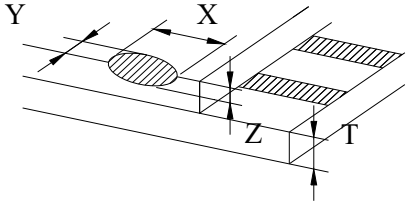
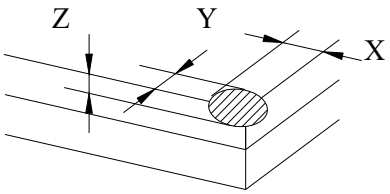
<table>
<tr><td>Point</td><td>Acceptable Qty.</td></tr>
<tr><td>Size</td><td></td></tr>
<tr><td>ϕ≤0.20</td><td>Disregard</td></tr>
<tr><td>0.20<ϕ≤0.25</td><td>3</td></tr>
<tr><td>0.25<ϕ≤0.30</td><td>2</td></tr>
<tr><td>ϕ>0.30</td><td>0</td></tr>
</table>
Unit：mm</td></tr>
<tr><td>4</td><td>Line defect</td><td> 

<table>
<tr><td></td><td>Line</td><td>Acceptable Qty.</td></tr>
<tr><td>L</td><td>W</td><td></td></tr>
<tr><td>---</td><td>0.015≥W</td><td>Disregard</td></tr>
<tr><td>3.0≥L</td><td>0.03≥W</td><td rowspan="2">2</td></tr>
<tr><td>2.0≥L</td><td>0.05≥W</td></tr>
<tr><td>1.0≥L</td><td>0.1 > W</td><td>1</td></tr>
<tr><td>---</td><td>0.05<W</td><td>Applied as point defect</td></tr>
</table>
Unit: mm</td></tr>
<tr><td>5</td><td>Rainbow</td><td>Not more than two color changes across the viewing area</td></tr>
</table>

<table>
<tr><th>No.</th><th>Item</th><th>Criterion</th></tr>
<tr><td>6</td><td>Segment pattern
W = Segment width
ϕ = (X+Y)/2</td><td>(1) Pin hole
ϕ < 0.10mm is acceptable.
 

<table>
<tr><td>Point Size</td><td>Acceptable Qty</td></tr>
<tr><td>ϕ≤1/4W</td><td>Disregard</td></tr>
<tr><td>1/4W< ϕ≤1/2W</td><td>1</td></tr>
<tr><td>ϕ > 1/2W</td><td>0</td></tr>
</table>
Unit: mm</td></tr>
<tr><td>7</td><td>Back-light</td><td>(1) The color of backlight should correspond its specification.
(2) Not allow flickering</td></tr>
<tr><td>8</td><td>Soldering</td><td>(1) Not allow heavy dirty and solder ball on PCB or FPC.
(The size of dirty refer to point and dust defect)
(2) Over 50% of lead should be soldered on Land.
 

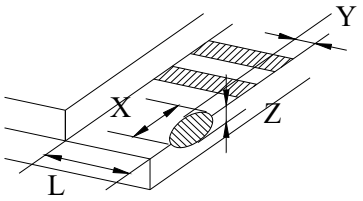
50% lead</td></tr>
<tr><td>9</td><td>Wire</td><td>(1) Copper wire should not be rusted
(2) Not allow crack on copper wire connection.
(3) Not allow reversing the position of the flat cable.
(4) Not allow exposed copper wire inside the flat cable.</td></tr>
<tr><td>10</td><td>PCB,FPC</td><td>(1) Not allow screw rust or damage.
(2) Not allow missing or wrong putting of component.</td></tr>
</table>

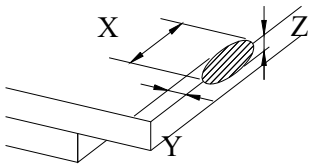
11	LCD	**2.1.1 chip on the surface**     Note: A:LCD Length X / Y / Z >1/8A / ≤0.3mm / ≤1/2T ≤1/8A / Not enter into epoxy frame / ≤T ≤1/8A / Not enter into the inner edge of epoxy / ≤1/2T

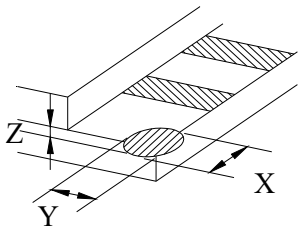
11

LCD

2.1.2 Chip on the terminal





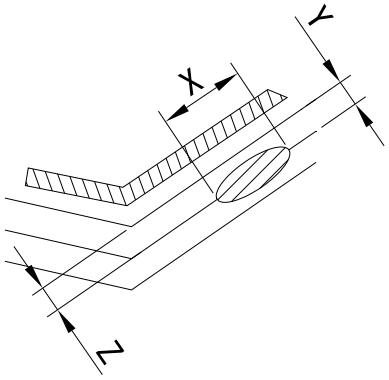


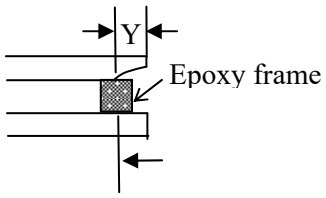
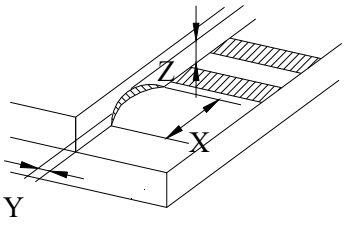
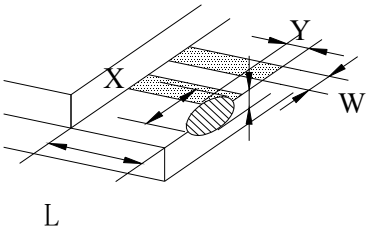
X	Y	Z
>1/8A	≤ 0.3mm	≤ 1/2T
≤ 1/8A	≤ 1/2L	≤ T
≤ 1/8A&≤ 1mm	≤ L	≤ T
≤ 1/8A&≤ 2mm	≤ L	≤ 1/2T

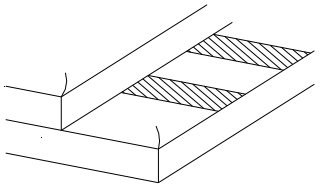
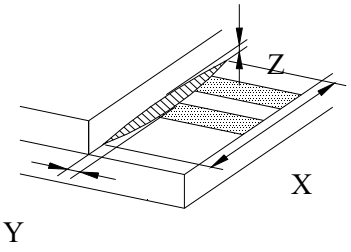
Note: A:LCD Length.

the distance between crack and contact pad must be greater than the width of 1st contact pad.

2.1.3 Chip out on between side



11	**LCD**	  X ≤ 1/8A: Y = Not enter into epoxy frame, Z ≤ 2T; Y = Not enter into 1/2 epoxy frame, Z ≤ 1/2T Note: A : LCD Length **2.1.4 including corner chip and side chip**  Note: A:LCD Length X: >1/8A, ≤1/8A, ≤1/4W; Y: ≤1/6L, ≤1/3L, ≤2/3L; Z: ≤1/2T

<table>
<tr><td rowspan="2">11</td><td rowspan="2">LCD</td><td>2.2 Chip out
 
1) Chip out is that crackles extend to inner edge.
2) Crackles round epoxy frame will be rejected.
3) Chip out on the terminal will be rejected: Z=T length >1mm or Z<T length >2mm
4) The chip out at ITO will be rejected.</td></tr>
<tr><td>2.3 Poor cutting
 

<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>>1/8 A</td><td>≤0.3</td><td>≤1/2T</td></tr>
<tr><td>≤1/8 A</td><td>According to drawing</td><td>1/2T≤Z≤T</td></tr>
</table>
Note : A: LCD Length.</td></tr>
<tr><td>12</td><td>SMT</td><td>According to the <Acceptable of electronic assemblies>
IPC-A-610C class 2 stander. Component missing or function defect are Major defect ,the others are Minor defect.</td></tr>
<tr><td colspan="3">Any one out of the specification will be rejected.</td></tr>
</table>

12. GENERAL PRECAUTIONS

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichlorotrifloroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Ketone
- Aromatics

(3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.

- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

(5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them.

However those phenomena do not mean malfunction or out of order with LCD's which will come back in the specified operating temperature range.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- As light dew depositing on terminals is a cause for electro-chemical reaction resulting in

terminal open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time (for instance, for years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is.

Keeping temperature in the specified storage temperature range.

- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol which should be burned up later.
- When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

- END -